
Hardware Security

with Microarchitecture Side Channels as Example

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Outline

- **Security goals - CIA**
- **Hardware stack (vs. software stack)**
 - **Technology/Transistors**
 - **Packaging/Board/System**
 - **Firmware**
 - **Software**
 - **Design process**
 - **Circuits, logic, RTL, architecture**
 - **Supply chain**
- **Security goals in the hardware context – CIA**
 - **Understand hardware attack surfaces**
 - **Threat**
 - **Vulnerability**
 - **Microarchitecture side-channels**
 - **Attack methods**
 - **Mitigation techniques**

Objectives of Information Security - CIA

- **Confidentiality**

- **Only authorized parties should be able to access the required data**
 - Access mean to understand the contents of the data
 - Should not disclose unnecessary content

- **Integrity**

- **The content should only be altered by authorized users intentionally**
 - Not tempered or degraded
 - Purposely or inadvertently
- **Non-repudiation**

- **Availability**

- **Timely accessibility of data to authorized entities when needed**
 - System availability
 - Communication channel accessibility
 - Data readiness

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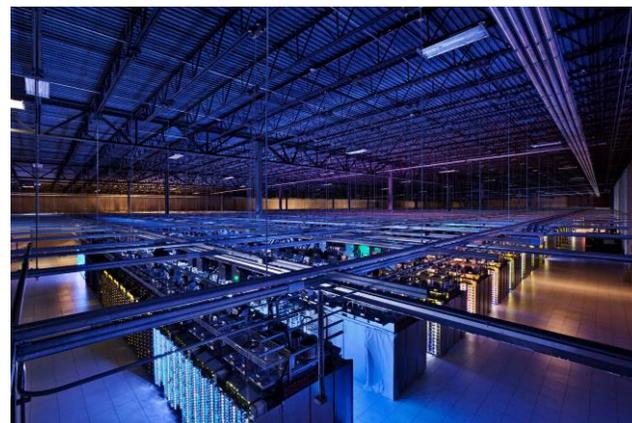
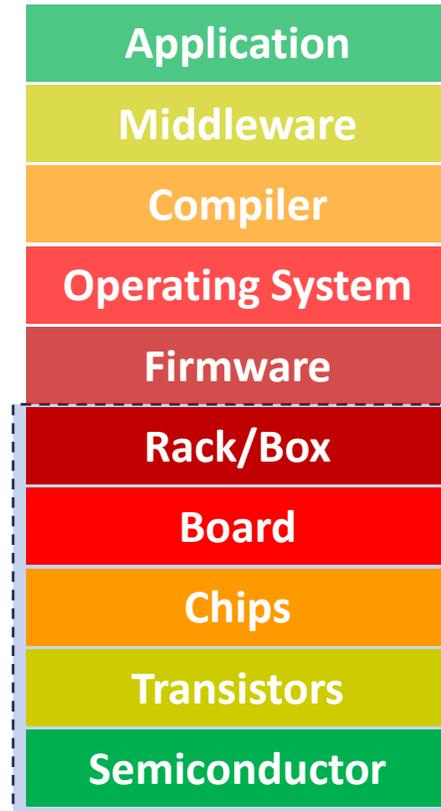
Hardware Stack (vs. Software Stack)

- **SW stack**

- **Layers/components translating an application for HW**
 - Middleware includes any API/library/functions
 - OS includes UI/services/runtimes
 - An additional layer may sit between OS and firmware (hypervisor)
 - Firmware includes BIOS/drivers

- **HW stack**

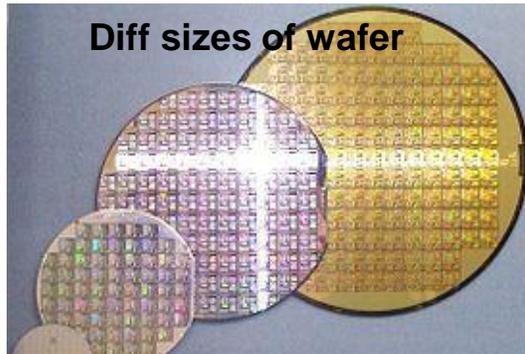
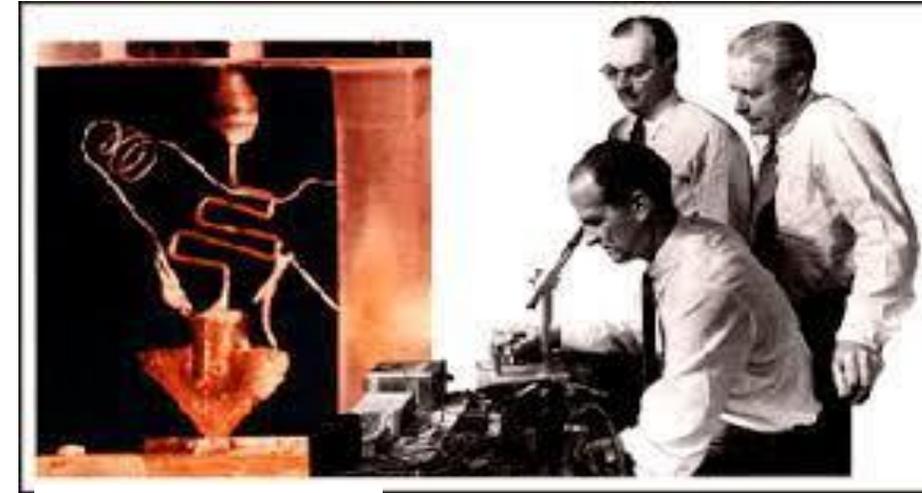
- **Layers/components to support the execution of software**
 - Rack may be pleural
 - Much of HW suppliers are outside of the US
 - Semiconductor
 - Recent resurgence of focus



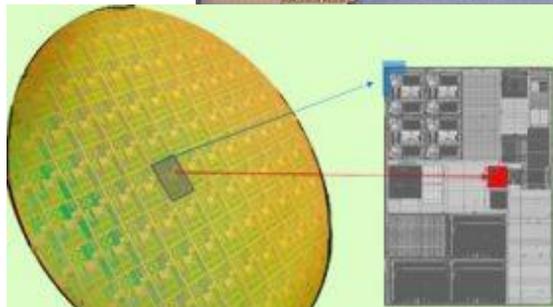
Semiconductor Technology/Transistors

- Transistors
 - One of the important invention
- Integration of devices
 - Many transistors on a substrate
- Manufacturing is moving offshore

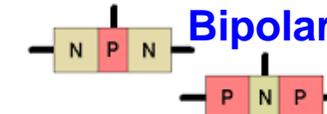
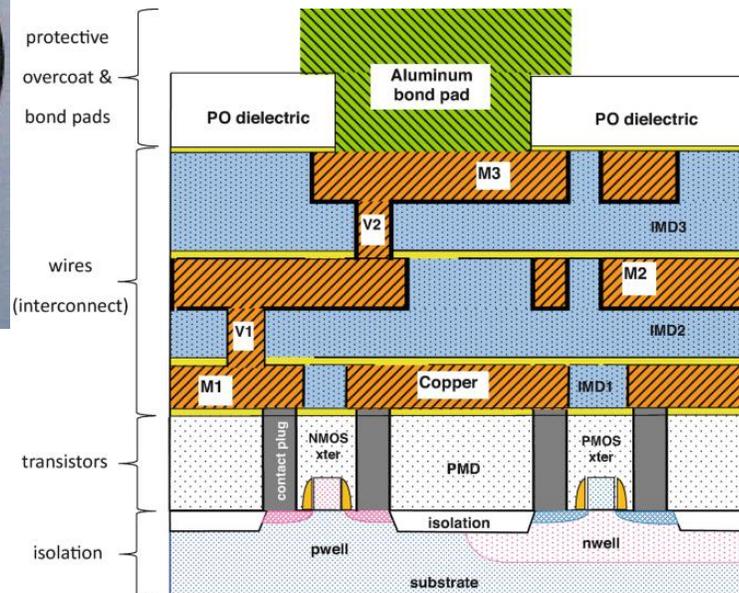
1st transistor (L) & the three “inventors”
(Bardeen, Brattain, and Shockley)



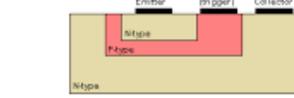
Diff sizes of wafer



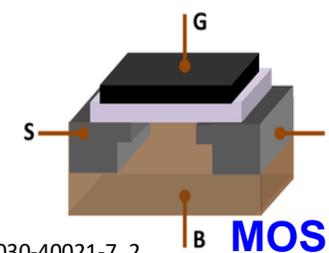
Multiple chips on a wafer



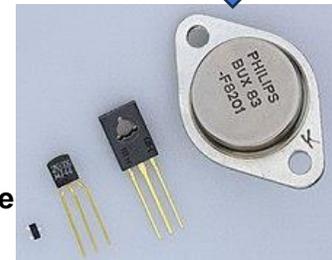
NPN (off)



NPN (on)



packaged



Vacuum Tube



1907

Transisto



1947

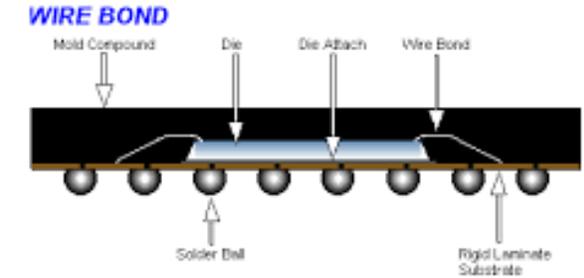
Integrated Circuit (IC)



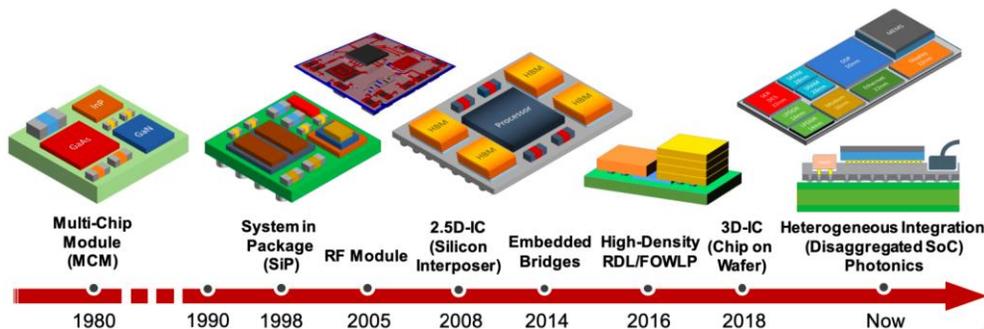
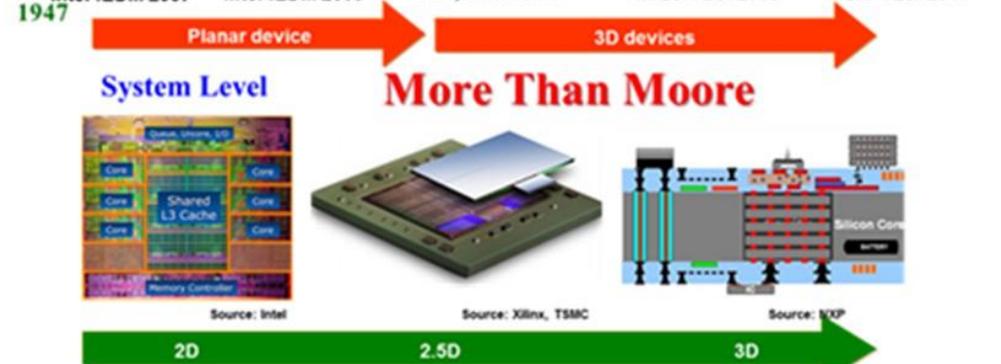
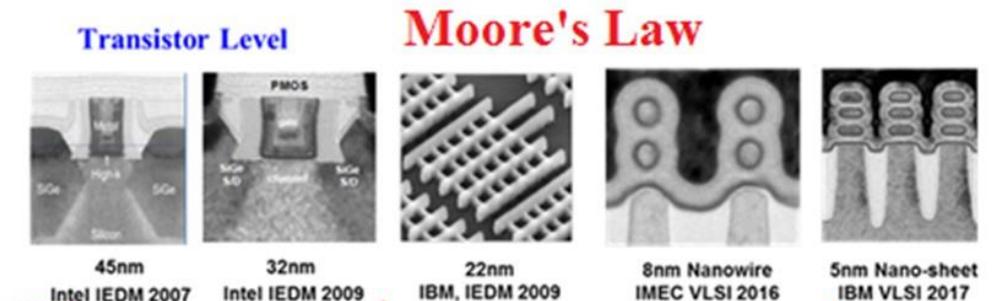
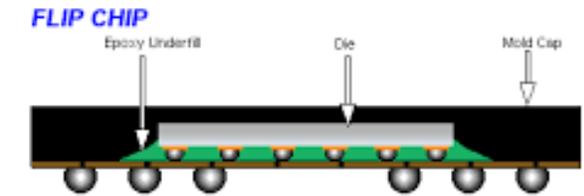
1963

Packaging/Assembly

- Packaging technologies matured
 - Moving off-shore
 - Supply chain
- More than Moore (MtM)
 - Packaging going 3D
 - IC die size has not shrunk with Moore's Law
 - Apply IC technology to packaging
 - Reduce physical footprint
 - Challenge - power density



<https://www.eetimes.com/the-package-interconnect-selection-quandary/>



Chips to Board to Rack to Room

Packaged chips on a board



Multiple racks



Roomful of racks



System with multiple boards



Firmware and Software

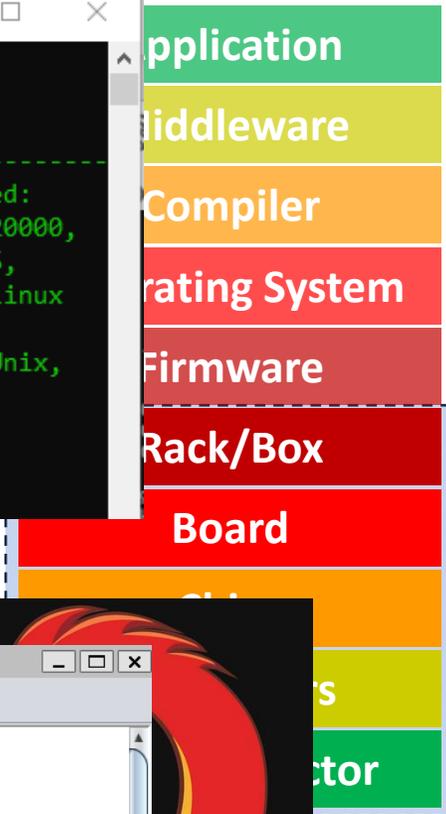
- Firmware
 - Software
 - May include
 - On most laptops
 - CptS426 w/
- Software

```
sllu@EVT-WSU-132: ~  
sllu@EVT-WSU-132:~$ binwalk -t vmlinux.gz.uImage
```

DECIMAL	HEXADECIMAL	DESCRIPTION
0	0x0	uImage header, header size: 64 bytes, header CRC: 0x8DD2855, created: 2018-10-25 08:11:29, image size: 983040 bytes, Data Address: 0x80020000, Entry Point: 0x8020E000, data CRC: 0x3663CBB2, OS: Linux, CPU: MIPS, image type: OS Kernel Image, compression type: gzip, image name: "Linux Kernel"
64	0x40	gzip compressed data, has original file name: "vmlinux.bin", from Unix, last modified: 2018-10-25 08:11:29

sllu@EVT-WSU-132:~\$ 2~

<https://www.kali.org/tools/binwalk/>



- Many tools to reverse engineer SW
- A very powerful one is Ghidra

Ghidra: NSA Reverse Engineering Software

Ghidra is a software reverse engineering (SRE) framework developed by NSA's Research Directorate. This framework includes a suite of full-featured, high-end software analysis tools that enable users to analyze compiled code on a variety of platforms including Windows, MacOS, and Linux. Capabilities include disassembly, assembly, decompilation, debugging, emulation, graphing, and scripting, along with hundreds of other features. Ghidra supports a wide variety of processor instruction sets and executable formats and can be run in both user-interactive and automated modes. Users may also develop their own Ghidra plug-in components and/or scripts using the exposed API. In addition there are numerous ways to extend Ghidra such as new processors, loaders/exporters, automated analyzers, and new visualizations.

In support of NSA's Cybersecurity mission, Ghidra was built to solve scaling and teaming problems on complex SRE efforts and to provide a customizable and extensible SRE research platform. NSA has applied Ghidra SRE capabilities to a variety of problems that involve analyzing malicious code and generating deep insights for NSA analysts who seek a better understanding of potential vulnerabilities in networks and systems.

What's New in Ghidra 10.4

The not-so-fine print: Please Read!

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Design Process

- **Start with specification**
- **Design the architecture (microarchitecture)**
- **Perform logic design**
 - HDL (C, System Verilog, Verilog, VHDL)
- **Circuit design**
 - Library cells
- **Physical layout**
 - GDSII
- **Mask generation – MEBES and OPC**
- **Fabrication – many months**
- **Packaging – 2D, 2.5D, 3D**
- **Testing – pre- and post testing**
- **Assembly – putting parts together**
- **System integration**

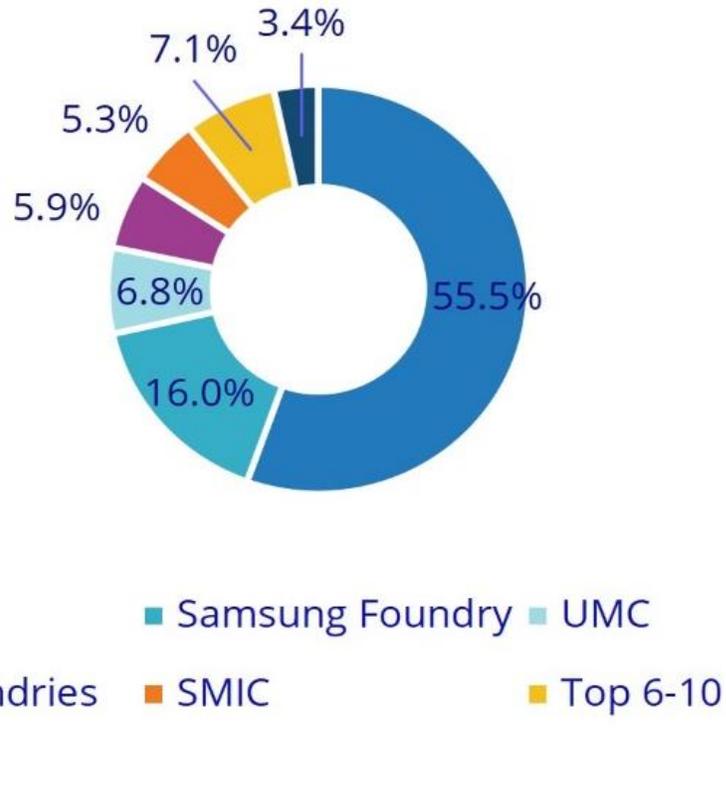


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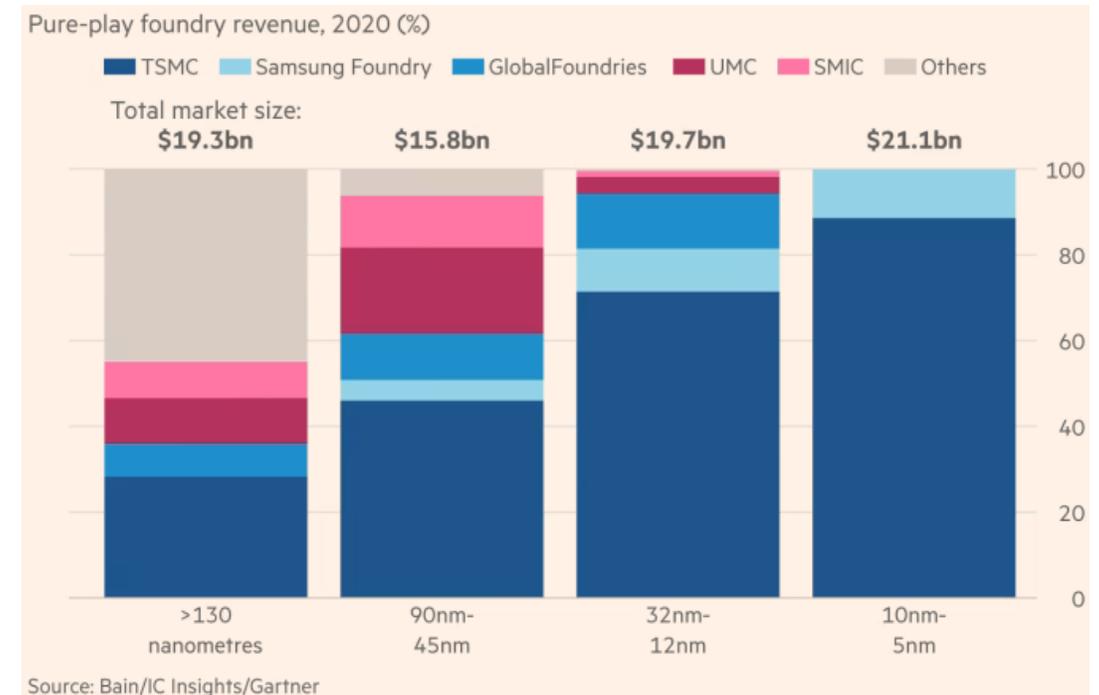
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Distribution of Semiconductor Foundry

- Total market share
 - TSMC (Taiwan Semiconductor Manufacturing Comp.) > 55%



- Advanced nodes
 - TSMC ~ 90%
 - > 90 % for the most advanced technology



<https://www.idc.com/getdoc.jsp?containerId=prAP50994023>

<https://www.ft.com/content/05206915-fd73-4a3a-92a5-6760ce965bd9>

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Security Goals (CIA) in the Hardware Context

- **Understand security terminology**
 - Threat (threat actor)
 - Vulnerability
 - Attack
- **Attack surfaces**
 - Places/areas that have vulnerability
 - Attack causes violation of security goals
- **Common attack methods**
 - Reverse engineering
 - Fault injection
 - Information leakage through side channels
- **Mitigation techniques**

Understand Security Terminology

- **Threat**
 - **Condition/circumstances causing violation of security goals (CIA)**
 - **Both intentional and unintentional (e.g. disaster, power outage)**
 - **Range from individuals to national state**
- **Vulnerability**
 - **Weakness**
 - **Bugs in design**
 - **Features**
 - **Misconfiguration or mis-operation**
 - **Allow threat actor to act**
- **Attack**
 - **Deliberate action**
 - **With motive and plan**

Attack Surfaces

• Places/areas that have vulnerability

• Actual hardware

- System
- Board
- Chip
- Interfaces
 - Between chips
 - Between boards
 - Between systems

• Design process

- Actual design
- Tools used for design
- Library cells (IPs)

• Supply chain

- Fabrication
- Assembly (2018 Bloomberg report on Supermicro)
- Integration

Bloomberg

• Live Now Markets Economics Industries Tech AI Politics Wealth Pursuits Opinion Businessweek Equality Green CityLab Crypto



The Long Hack: How China Exploited a U.S. Tech Supplier

For years, U.S. investigators found tampering in products made by Super Micro Computer Inc. The company says it was never told. Neither was the public.

By Jordan Robertson and Michael Riley

Specification and Design

System Integration

- **Reverse engineering**
 - **System**
 - firmware
 - **Board**
 - **Chip - FPGA**
 - Zeroization
- **Fault injection**
 - **Perturbation**
 - Temperature
 - Voltage
 - Clock
 - **Causing system to leak information**
- **Side channels**
 - **Physical**
 - **Microarchitectural**



The screenshot shows the top portion of an ABC News article. The navigation bar includes the ABC News logo, 'VIDEO', 'LIVE', 'SHOWS', 'ELECTION 2024', and '538'. The article title is 'Bush Calls on China to Return Spy Plane and Crew'. The byline is 'By ABC News' and the date is 'April 2, 2001, 12:01 AM'. There are social media sharing icons for Facebook, Twitter, Email, and a link icon. The main text begins with 'April 2 -- Voicing concern over China's refusal to grant access to the 24 crew members on a downed U.S. Navy surveillance aircraft, President Bush today said he was troubled by the Chinese government's inaction.' A subsequent paragraph states 'Bush also called on the Chinese government to return the super surveillance EP-3 Aries plane "without further damaging or tampering."' The final paragraph reads 'The U.S. Navy reconnaissance plane made an emergency landing at a military air base on the Chinese island of Hainan after colliding with a Chinese fighter jet late Saturday (local time). The Chinese fighter and its pilot are still reported missing'.

abc NEWS VIDEO LIVE SHOWS ELECTION 2024 538

Bush Calls on China to Return Spy Plane and Crew

By ABC News
April 2, 2001, 12:01 AM

April 2 -- Voicing concern over China's refusal to grant access to the 24 crew members on a downed U.S. Navy surveillance aircraft, President Bush today said he was troubled by the Chinese government's inaction.

Bush also called on the Chinese government to return the super surveillance EP-3 Aries plane "without further damaging or tampering."

The U.S. Navy reconnaissance plane made an emergency landing at a military air base on the Chinese island of Hainan after colliding with a Chinese fighter jet late Saturday (local time). The Chinese fighter and its pilot are still reported missing

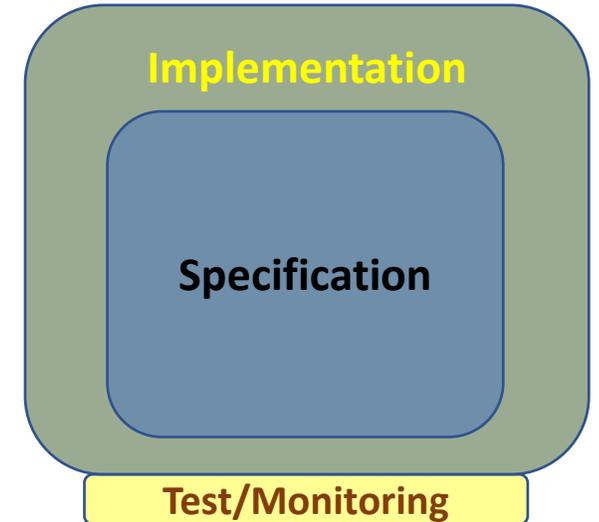
<https://abcnews.go.com/International/story?id=81317>

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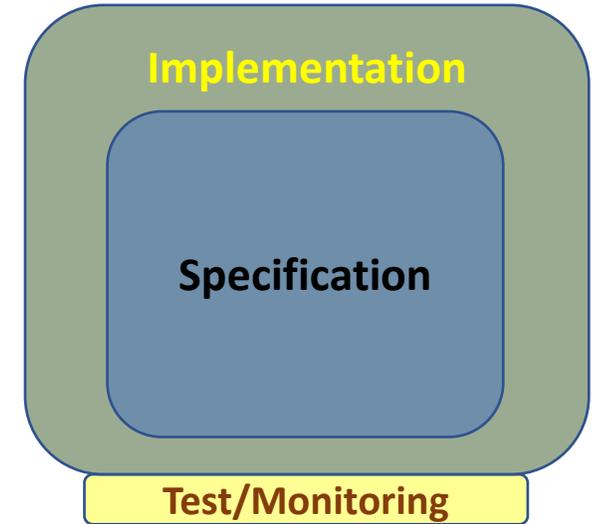
Microarchitecture Side-Channels

- **Why is security challenging (especially in HW context)?**
 - **Correctness**
 - Met specification (e.g. ISA spec)
 - **No vulnerability means ...**
 - No extra features beyond the specification
 - No side-channels
 - Speculation
 - Transient states
 - Physical manifestation
 - **But we want ...**
 - Performance
 - Observability
 - Testing/debugging
 - ...



What is Microarchitecture? Why?

- **Implementation of Instruction Set Architecture (ISA)**
 - Ex. Of ISA x86-64, ARMv8-A, RISC-V, MIPS
 - ISA is the specification
- **Multiple implementations of one ISA to get:**
 - Performance
 - Power efficiency
 - Observability
 - Testability
 - Security!
 - Etc.
- **SW interactions with the implementation**
 - Observable

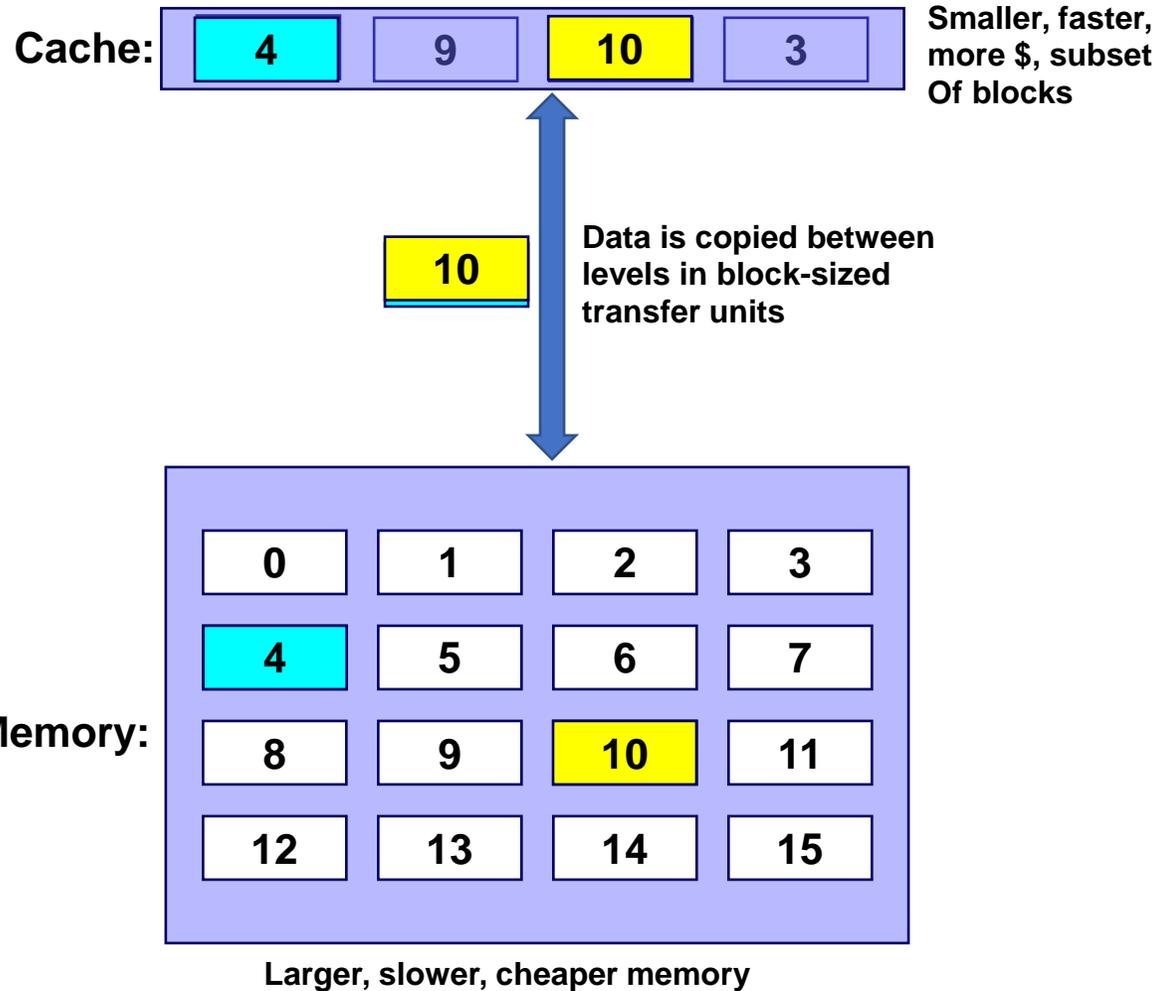


Microarchitectural Side-Channels

- **Why this is so insidious?**
 - **Need no physical access**
 - **Cloud: multi-tenant**
 - **Threat agent is a “legitimate” tenant of the cloud**
 - **Shared resource as the covert channel**
 - **Host has no explicit control of the share resources**
 - **Behavior can be affected/observed by another tenant**
 - **Conflicting goals – performance vs. security**
 - **Slowing down of Moore’s law → more microarchitecture optimization**
 - **Increasing attack surfaces**
- **Cause**
 - **Speed up common cases**
 - **Lower latency when the “technique” works**
 - **Longer latency otherwise**
 - **Performance monitoring mechanisms**

Passive Information Gathering & Active Information Leakage

- High-level intro to cache



- Principles behind caching

- Temporal locality

- Re-use of specific data in time

- Spatial locality

- Use of data close to each other

- Example loop:

- `for (.....) { sum=sum+x[i];}`

- When CPU read

- Cache Hit

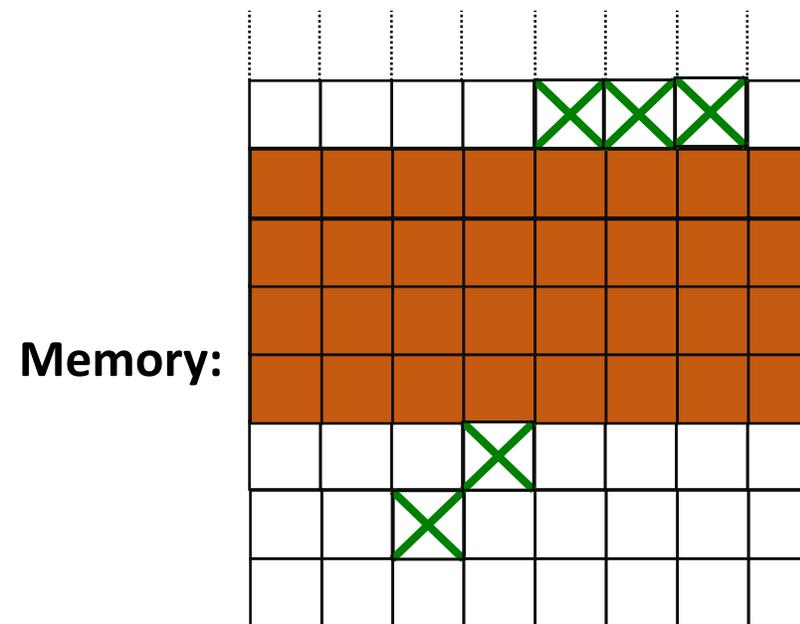
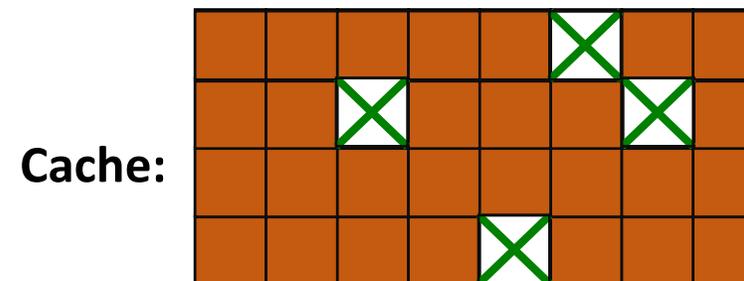
- Fast – lower latency

- Cache Miss

- Slow – longer latency

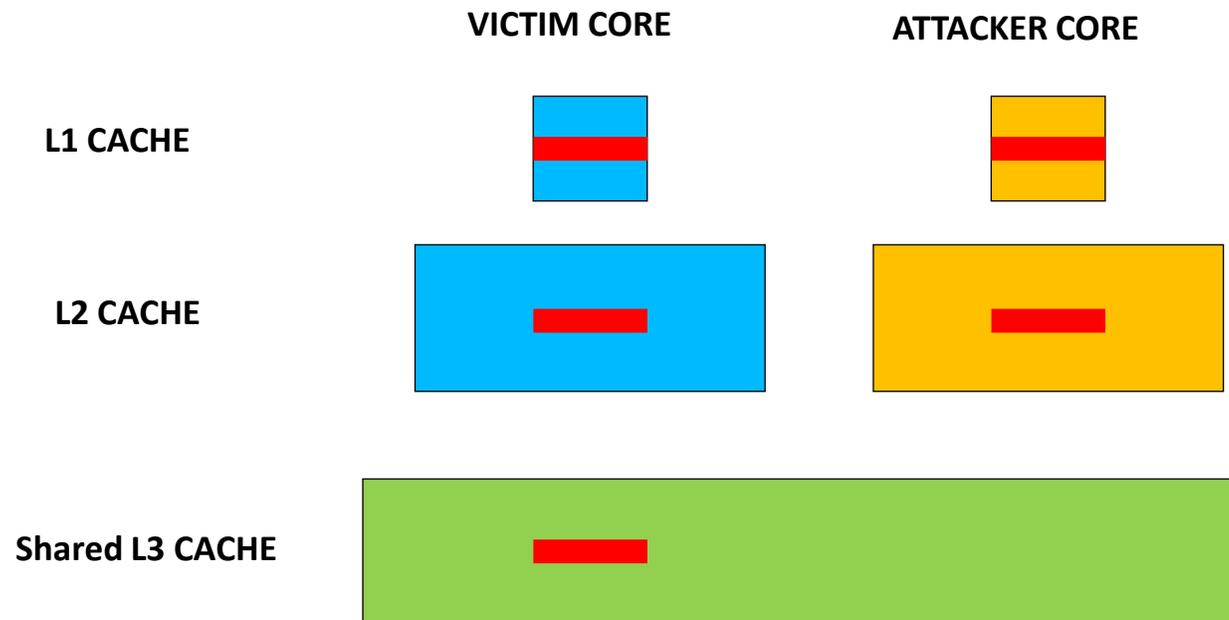
Prime+Probe [Per05, OST06]

- Attacker chooses a cache-sized memory buffer
- Attacker accesses all the lines in the buffer, filling the cache with its data
- Victim executes, evicting some of the attacker's lines from the cache
- Attacker measures the time to access the buffer
 - Accesses to cached lines is faster than to evicted lines
 - Learn victim's address



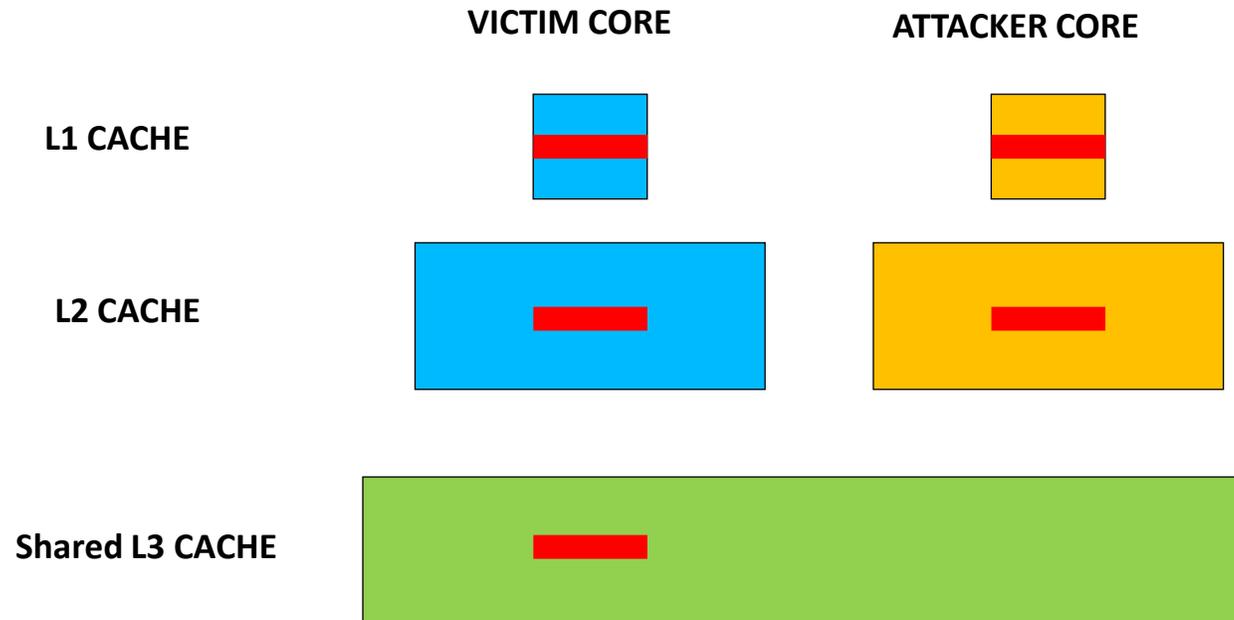
Flush+Reload [Y&F14]

- Work on cache lines (vs. cache sets in Prime+Probe)
- Needs physical memory sharing with victim
- Attacker use “`CLFLUSH`” to evict line
- Due to inclusive property victim private cache line evicted also



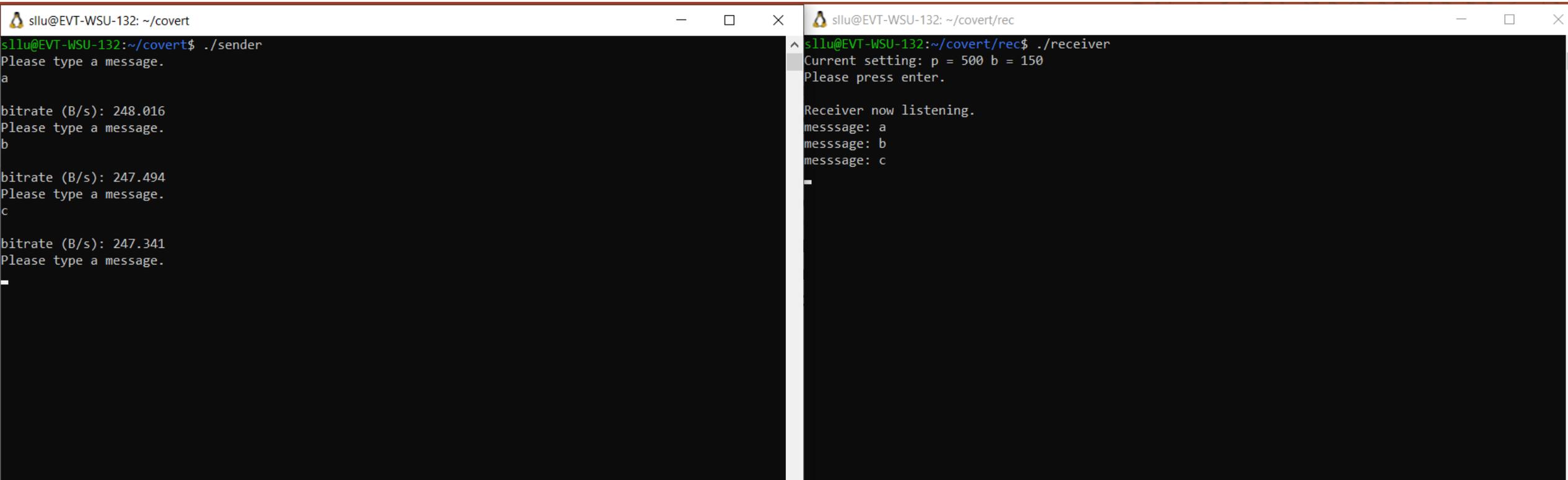
Flush+Reload (Cont.)

- Attacker waits
- Victim reload the cache line
- Attacker reload and use read time stamp counter to time (rdtsc)
 - If fast then line in L3 (used by victim) else in DRAM (not used by victim)



A Demo of Cache Covert Channel

- What can threat actor do with cache side channels?
 - Cryptographic key leakage
 - A simple way to establish a covert channel to leak data



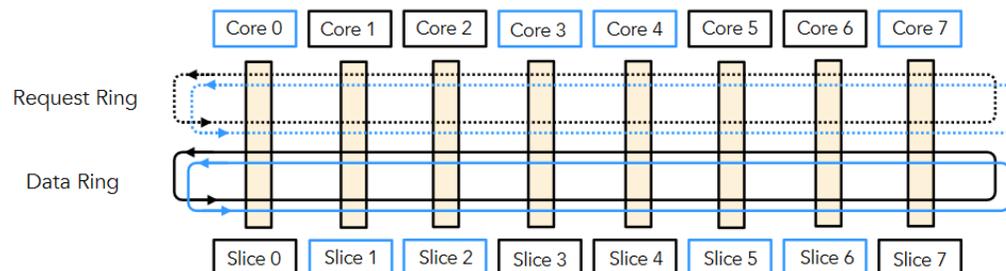
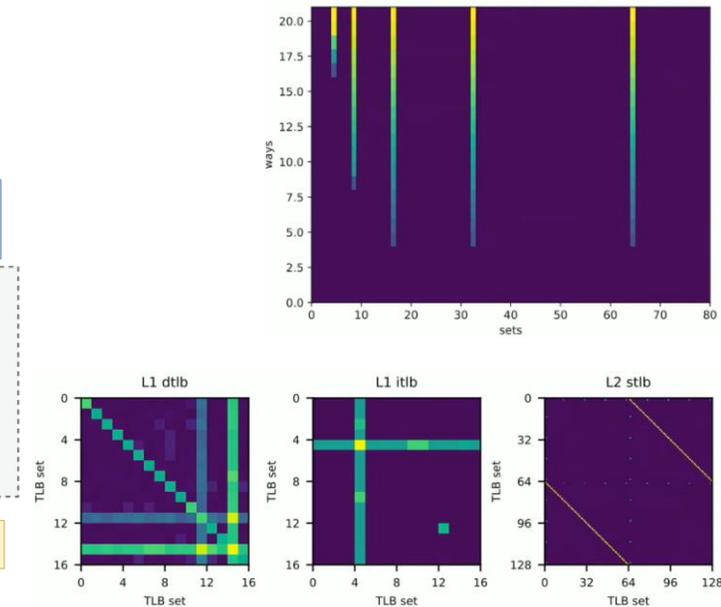
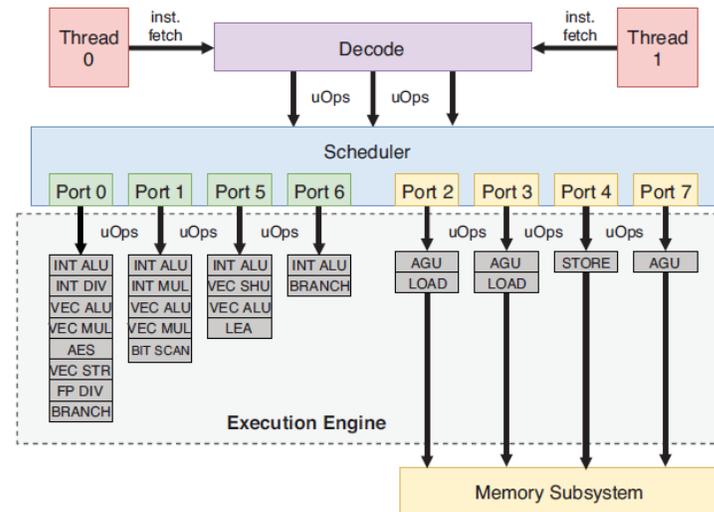
```
sllu@EVT-WSU-132: ~/covert
sllu@EVT-WSU-132:~/covert$ ./sender
Please type a message.
a
bitrate (B/s): 248.016
Please type a message.
b
bitrate (B/s): 247.494
Please type a message.
c
bitrate (B/s): 247.341
Please type a message.
_

sllu@EVT-WSU-132: ~/covert/rec
sllu@EVT-WSU-132:~/covert/rec$ ./receiver
Current setting: p = 500 b = 150
Please press enter.

Receiver now listening.
message: a
message: b
message: c
_
```

Other On-Chip Shared Structures

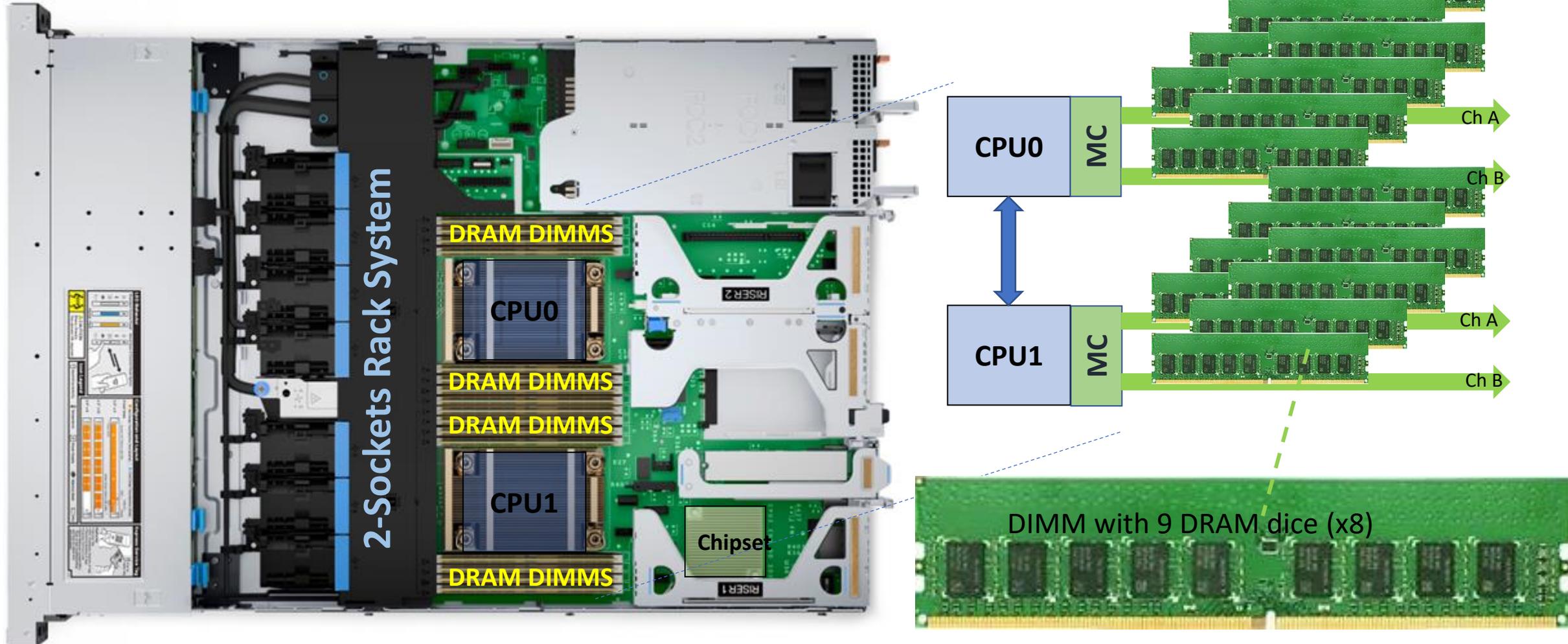
- TLBs [Gra 18]
 - L1iTLB, L1dTLB, L2TLB contention
 - Reverse engineered by experimenting with page walks and perf cntnr
 - Access set of L1dTLB and observe sharing between two threads
 - Observe EdDSA ECC key multiplication
- Functional Units [Ald 19]
 - Port contention of SMT
- On-chip networks [PLF 20]
 - Ring contention
 - Overlapped segments



Translation Leak-aside Buffer: Defeating Cache Side-channel Protections with TLB Attacks, 27th USENIX Security Symp. 2018
 Port Contention for Fun and Profit. In 2019 IEEE Symposium on Security and Privacy (SP). 2019
 Lord of the Ring(s): Side Channel Attacks on the CPU On-Chip Ring Interconnect Are Practical, 30th USENIX Security Symp. 2021

DRAM in a Computer System

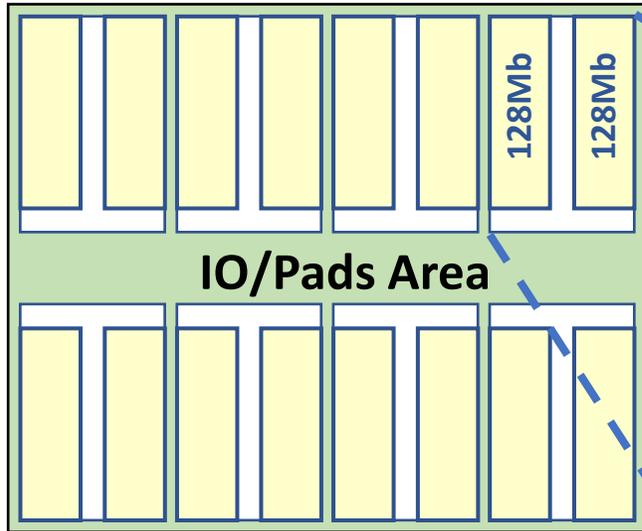
- Non-inclusive L3
- Isolate on-chip shared L3



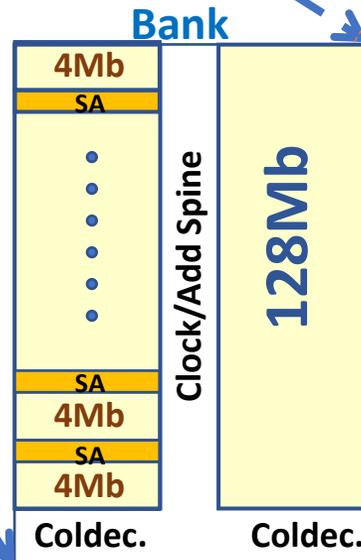
DRAM Die Internal

- Banks are independent

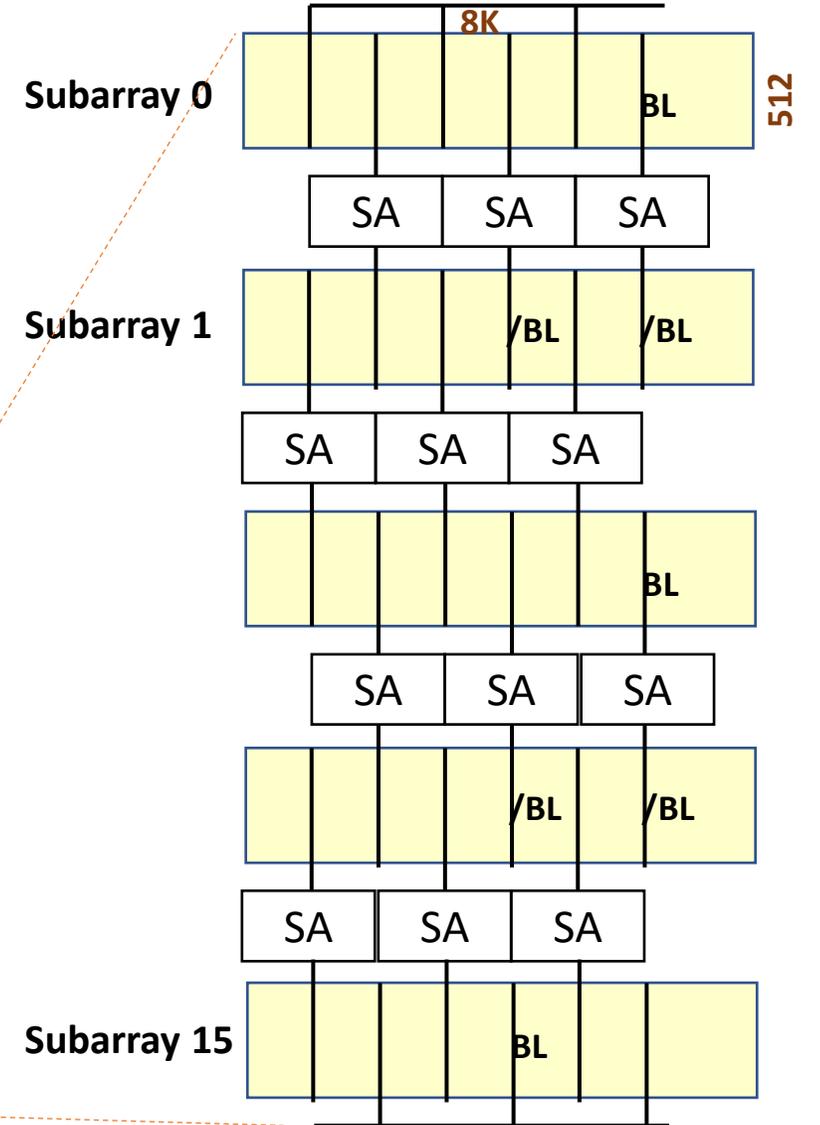
Example of 2Gb DRAM Die Organization



**128Mb Half Bank Includes
32 SA Bands and
33 4Mb sub-arrays.**

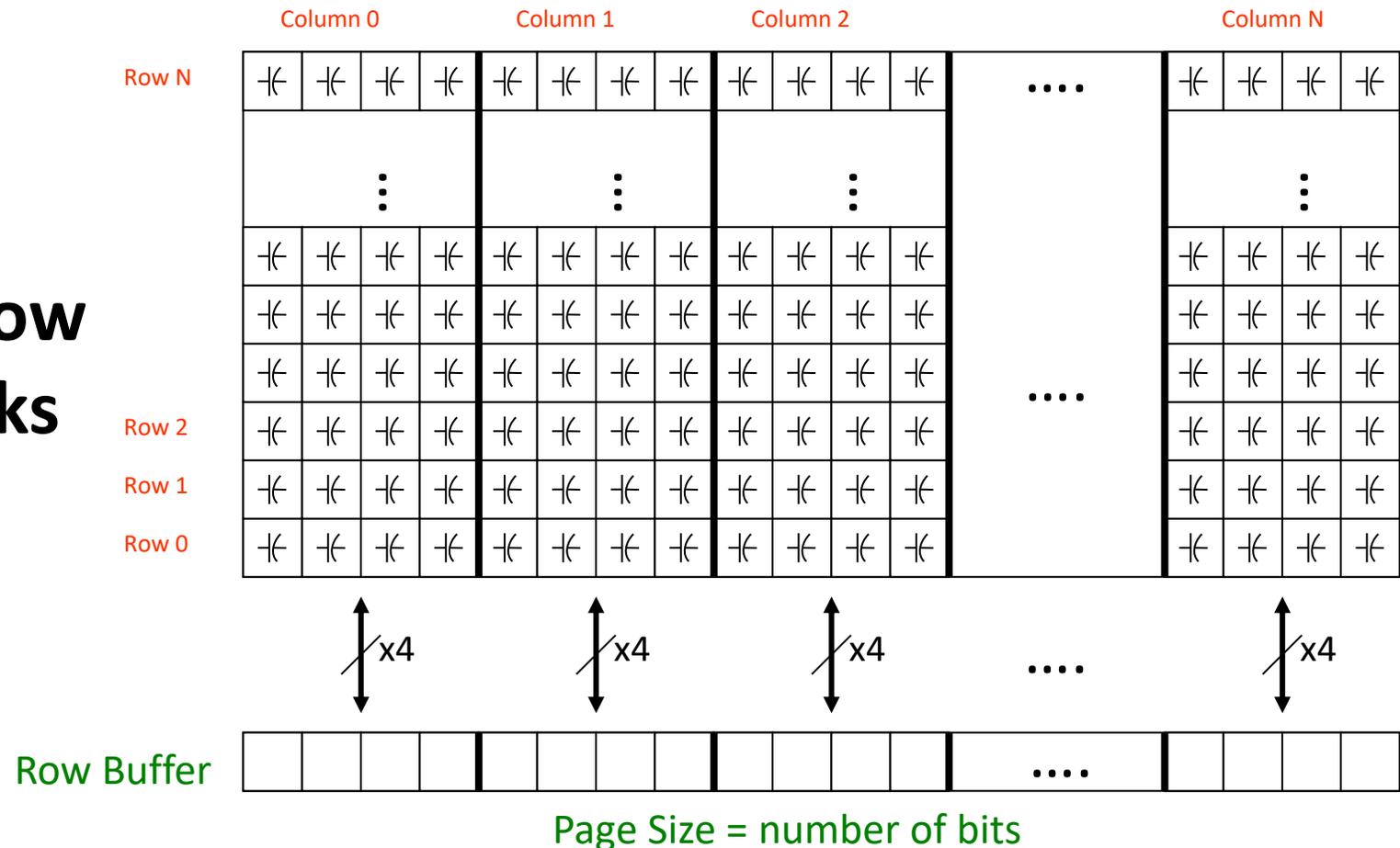


OPEN BL in Commodity DRAM



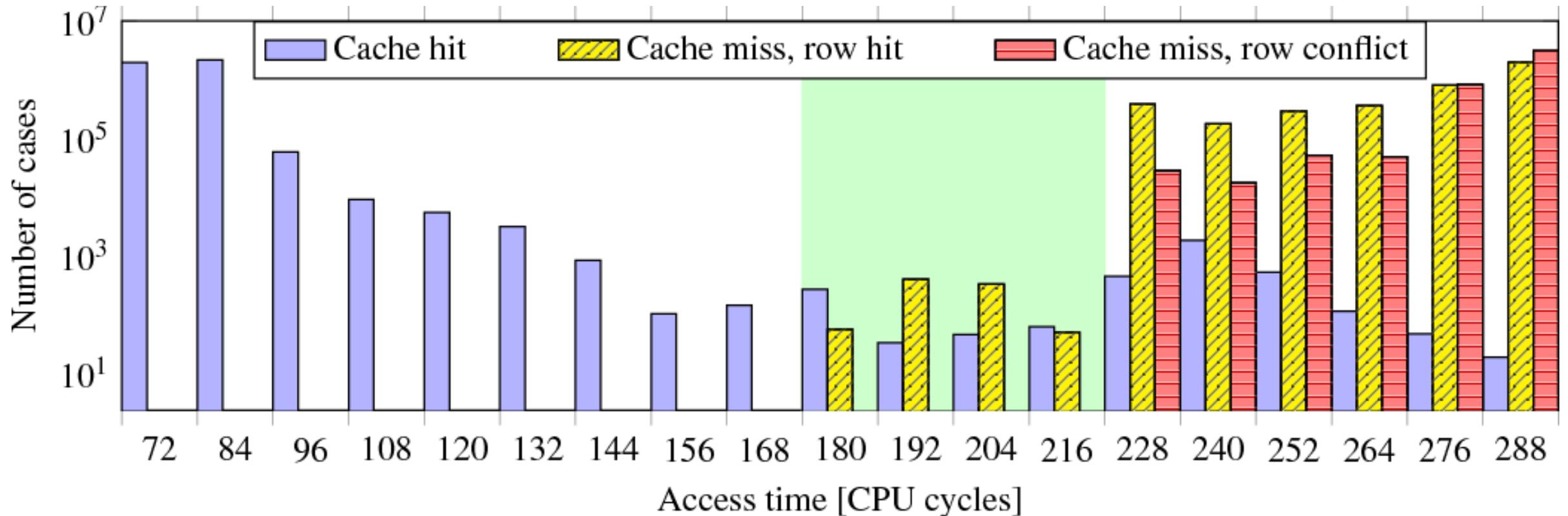
DRAM Internal Abstraction – Page of 8K

- ACT – activate a row/page (tRAS)
- Read a portion of bits out (burst)
- Page policy
 - Close page
 - Open page
 - Locality
- Access to same bank slow
- Access to different banks
 - faster



Access Time Disparity Due to Row Buffer [PGM16]

- Behavior of memory access time
 - Row hits – lower latency (180-216 cycles no row conflicts)
 - Row miss/conflicts – higher latency



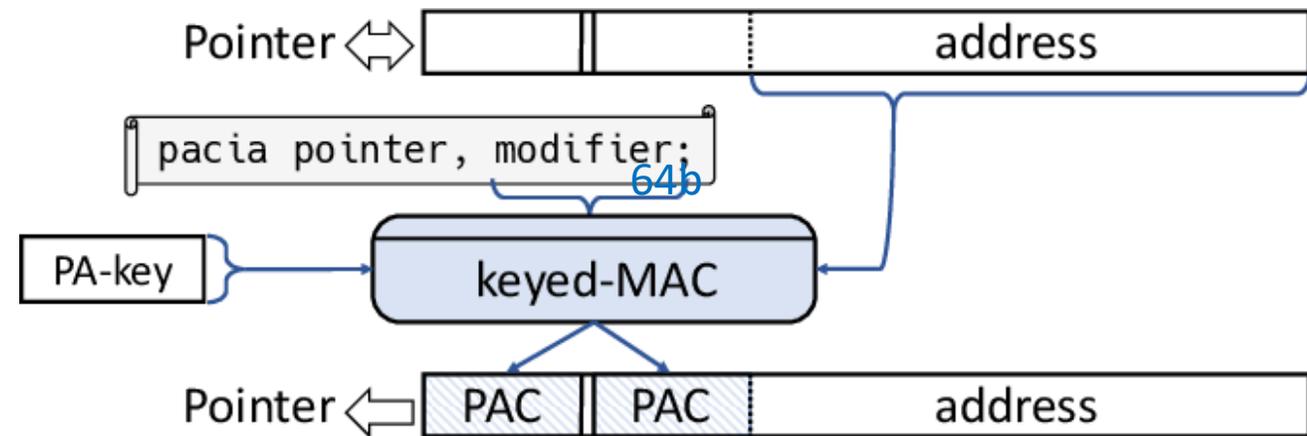
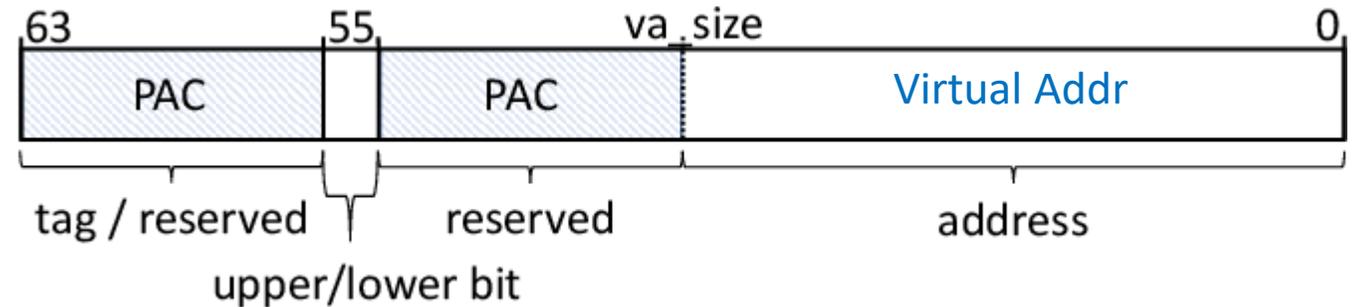
Vulnerability in Transient State

- **Speculative execution**
 - **Common performance improvement technology in modern processors**
 - Branch prediction
 - Speculatively load
 - **Software security requirement**
 - CPUs runs instructions correctly
 - Discard mistakes and re-run
 - **“Private” data are in the HW speculatively (will get flushed eventually)**
 - Observable
 - Leaking private information
- **Famous examples**
 - **Meltdown and Spectre [Koch19]**
 - **Google project zero**



Security Enhancement Structure - PAC Vulnerability

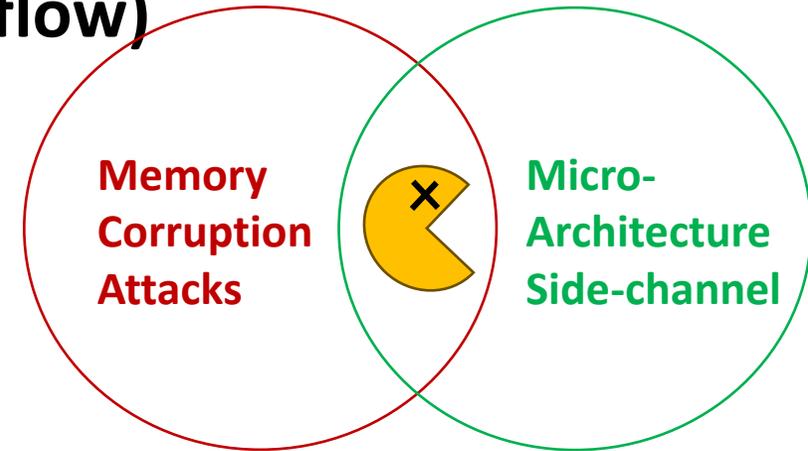
- What is PAC (Pointer Authentication Codes)?
 - A “security” feature from ARM to guard against pointer integrity
 - ARMv8.3-A
 - Unused address bits
 - Dynamically instrumented
 - Add PAC (`pacia__`)
 - Authenticate (`autia__`)
 - Usage example – func call
 - Entry – create a PAC in LR
 - Exit – check LR



```
function :
  paciasp                ; ① create PAC
  stp FP, LR, [SP, #0] ; store LR
  ; ...
  ldp FP, LR, [SP, #0] ; load LR
  autiasp                ; ② authenticate
  ret                    ; return
```

Apple M1 PACMAN Attack [Rav 22]

- Leveraging microarchitecture side-channel & memory corruption
 - PAC protects illegal memory access (buffer overflow)
 - Verify the signature (hash)
 - If different system halts
 - But ... there is the speculation state!
 - Guess the hash in speculation state



```

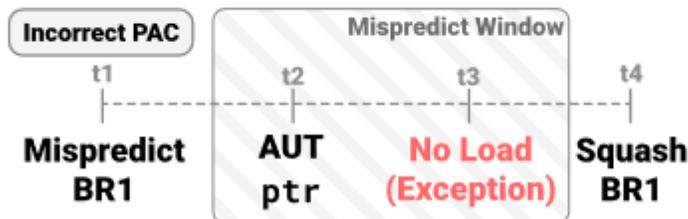
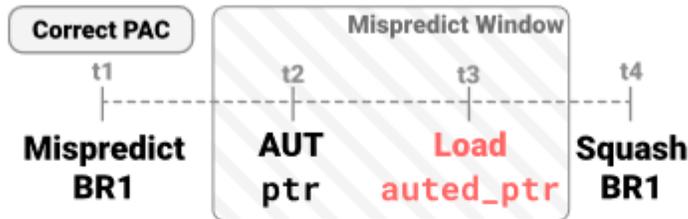
1 if (cond): #BR1
2   verified_ptr = AUT(guess_ptr)
3   Load(verified_ptr)
  
```

(a) A data PACMAN gadget.

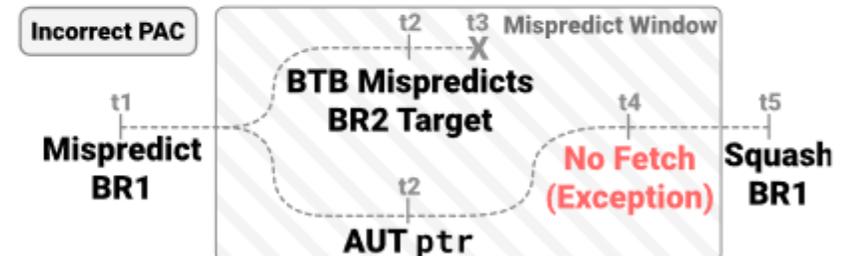
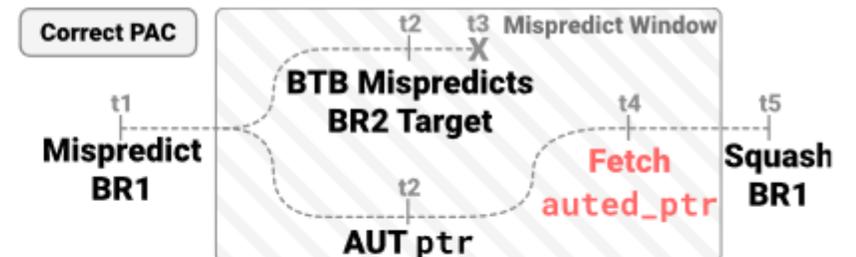
```

1 if (cond): #BR1
2   verified_ptr = AUT(guess_ptr)
3   BR verified_ptr #BR2
  
```

(b) An instruction PACMAN gadget.



(c) Timeline for data access leak.



(d) Timeline for instruction fetch leak.

Outline

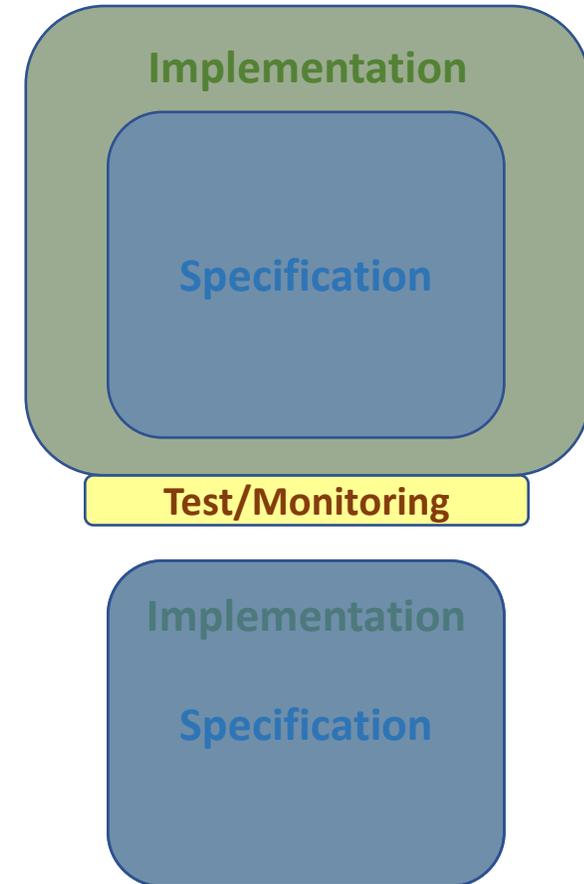
- Security goals - CIA
- Hardware stack (vs. software stack)
 - Technology/Transistors
 - Packaging/Board/System
 - Firmware
 - Software
 - Design process
 - Circuits, logic, RTL, architecture
 - Supply chain
- Security goals in the hardware context – CIA
 - Understand hardware attack surfaces
 - Threat
 - Vulnerability
 - Microarchitecture side-channels
 - Attack methods
 - **Mitigation techniques**

Mitigation Starts with Understanding

- **Classification**
 - **Side-channels enabled by**
 - Shared structures
 - Speculation
 - Performance counters
 - **Channel types**
 - **Persistent**
 - States that persist until next events
 - **Ephemeral**
 - Transient states – attacker/victim must cohabit
 - **Attack types**
 - **Active**
 - Affects victim
 - **Passive**

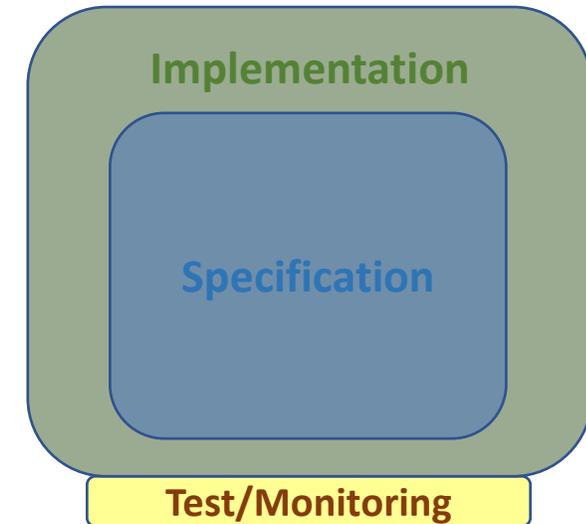
Mitigation

- **Complete clean slate design**
 - **Compatibility challenge**
 - **Cost – formal verification?**
- **Mitigation**
 - **Partition**
 - **Strick isolation**
 - **No shared structures**
 - **Performance impact**
 - **Obfuscation**
 - **Add noise**



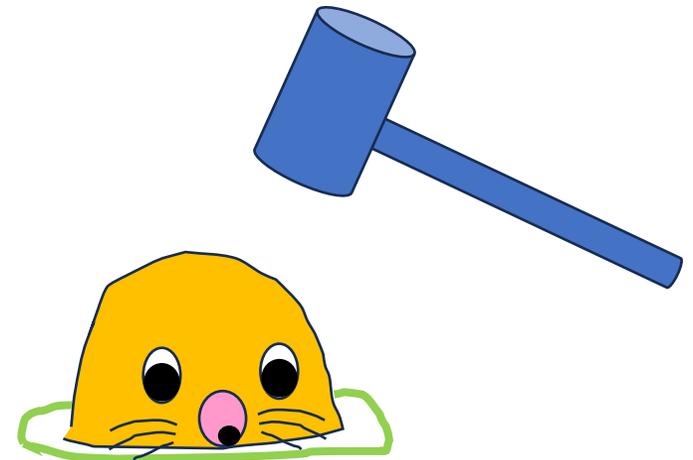
Possible Obfuscation Approaches

- **Static analysis/data analytic**
 - Given an implementation
 - Formalize all potential modulation
 - To mitigate one must find the modulation
 - Aid in reverse engineering
 - Build graph - evaluate
- **Dynamic monitoring**
 - Detection of active leakage
 - Patterns?
 - Does it need performance counters?
- **Dynamic randomization - obfuscation**
 - Source side
 - Intelligent fuzzing of software
 - System side
 - Insertion of disturbance
 - Maximize effect of noise while minimize effects on performance



Summary

- **Security is important when there is no trust**
- **Security is challenging**
- **Microarchitecture side channel is particularly dangerous**
 - No need for physical access
 - Against design goals
 - Increasing attack surfaces
- **Possible approach**
 - Static
 - Dynamic
 - Need efficient and general solution



Q & A